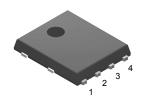
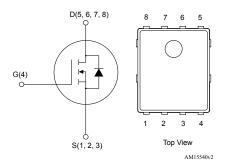


Automotive N-channel logic level 40 V, 1.0 mΩ max., 304 A STripFET F8 Power MOSFET in a PowerFLAT 5x6 package



PowerFLAT 5x6



Features

Order code	V _{DS}	R _{DS(on)} max.	l _D
STL305N4LF8AG	40 V	1.0 mΩ	304 A



- AEC-Q101 qualified
- MSL1 grade
- 175 °C maximum operating junction temperature
- 100% avalanche tested
- Low gate charge Q_q
- · Wettable flank package

Applications

- Automotive motor control
- Body and convenience
- · Chassis and safety
- Power train for ICE

Description





The STL305N4LF8AG is a 40 V N-channel enhancement mode Power MOSFET designed in STripFET F8 technology featuring an enhanced trench gate structure.

It ensures a state-of-the-art of figure of merit for very low on-state resistance while reducing internal capacitances and gate charge for faster and more efficient switching.

Product status link STL305N4LF8AG

Product summary			
Order code	STL305N4LF8AG		
Marking	305N4LF8		
Package PowerFLAT 5x6			
Packing Tape and reel			



1 Electrical ratings

Table 1. Absolute maximum ratings (at T_C = 25 °C unless otherwise specified)

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	40	V
V _{GS}	Gate-source voltage	±16	V
	Drain current (continuous) at T _C = 25 °C ⁽²⁾	304	
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C ⁽²⁾	215	Α
	Drain current (continuous) at T _C = 25 °C ⁽³⁾	120	
I _{DM} ⁽¹⁾⁽²⁾⁽⁴⁾	Drain current (pulsed), t _P = 10 μs	1217	Α
P _{TOT}	Total power dissipation at T _C = 25 °C	167	W
I _{AS}	Single pulse avalanche current (pulse width limited by T _J max.)	60	А
E _{AS}	Single pulse avalanche energy (starting T_J = 25 °C, I_D = 60 A, R_{Gmin} = 25 Ω)	420	mJ
TJ	Operating junction temperature range	-55 to 175	°C
T _{stg}	Storage temperature range	-55 to 175	°C

- 1. Specified by design, not tested in production.
- 2. This is the theoretical current value only related to the silicon.
- 3. This current value is limited by package.
- 4. Pulse width is limited by safe operating area.

Table 2. Thermal data

Sym	ibol	Parameter	Value	Unit
R _{thJ}	JA ⁽¹⁾	Thermal resistance, junction-to-ambient (on 2s2p FR-4 board vertical in still area)	16.5	°C/W
R _{th}	ıJC	Thermal resistance, junction-to-case	0.9	°C/W

1. Defined according to JEDEC standards (JESD51-5, -7).

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2 Electrical characteristics

 T_J = 25 °C unless otherwise specified.

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	40			V
1	Zono moto vielto no due in comunit	V _{DS} = 40 V, V _{GS} = 0 V			1	
I _{DSS}	Zero gate voltage drain current	V _{DS} = 40 V, V _{GS} = 0 V, T _J = 125 °C ⁽¹⁾			100	μΑ
I _{GSS}	Gate-body leakage current	V _{GS} = 16 V, V _{DS} = 0 V			100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2		2.0	V
Pno	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 60 A		0.8	1.0	mΩ
R _{DS(on)}		V _{GS} = 4.5 V, I _D = 60 A		1.15	1.5	11122

^{1.} Specified by design and evaluated by characterization, not tested in production.

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} ⁽¹⁾	Input capacitance		-	5400	-	pF
C _{oss} ⁽¹⁾	Output capacitance	V_{DS} = 25 V, f = 1 MHz, V_{GS} = 0 V	-	1700	-	pF
C _{rss} ⁽¹⁾	Reverse transfer capacitance			25	-	pF
Qg ⁽¹⁾	Total gate charge	V_{DD} = 20 V, I_{D} = 120 A, V_{GS} = 0 to 4.5 V	-	30	-	nC
		V _{DD} = 20 V, I _D = 120 A, V _{GS} = 0 to 10 V		70		IIC
Q _{gs} ⁽¹⁾	Gate-source charge	Sate-source charge $V_{DD} = 20 \text{ V}, I_D = 120 \text{ A}, V_{GS} = 0 \text{ to } 4.5 \text{ V}$		19	-	nC
Q _{gd} ⁽¹⁾	Gate-drain charge	ν _{DD} - 20 ν, ι _D - 120 A, ν _{GS} - 0 to 4.3 ν	-	5	-	nC

^{1.} Specified by design and evaluated by characterization, not tested in production.

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} ⁽¹⁾	Turn-on delay time			14	-	ns
t _r ⁽¹⁾	Rise time	V _{DD} = 20 V, I _D = 60 A,	-	6	-	ns
t _{d(off)} ⁽¹⁾	Turn-off delay time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$	-	55	-	ns
t _f ⁽¹⁾	Fall time			9	-	ns

^{1.} Specified by design and evaluated by characterization, not tested in production.

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Table 6. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD} ⁽¹⁾⁽²⁾	Forward on current (continuous)	T _C = 25 °C	-		121	Α
V _{SD}	Forward on voltage	I _{SD} = 60 A, V _{GS} = 0 V	-		1.1	V
t _{rr} ⁽¹⁾	Reverse recovery time		-	60		ns
Q _{rr} ⁽¹⁾	Reverse recovery charge	$I_D = 60 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, V_{DD} = 32 \text{ V}$	-	70		nC
I _{RRM} ⁽¹⁾	Reverse recovery current		-	2.5		Α

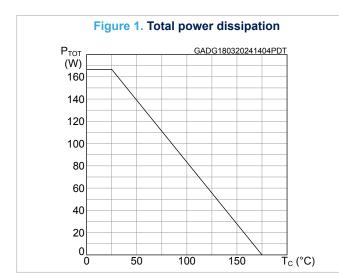
^{1.} Specified by design and evaluated by characterization, not tested in production.

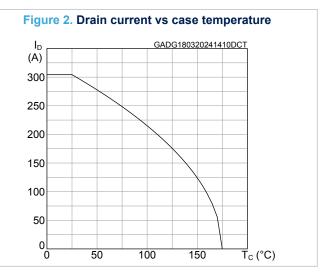
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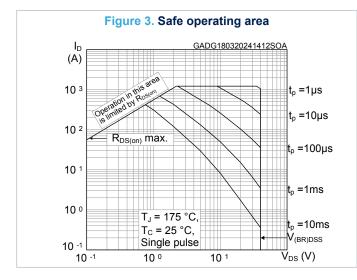
^{2.} This is the theoretical current value only related to the silicon.

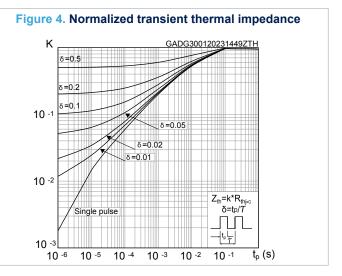


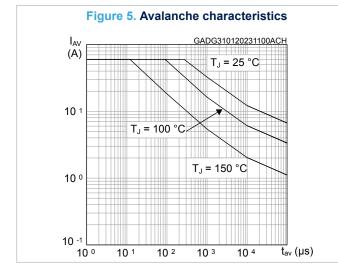
2.1 Electrical characteristics (curves)

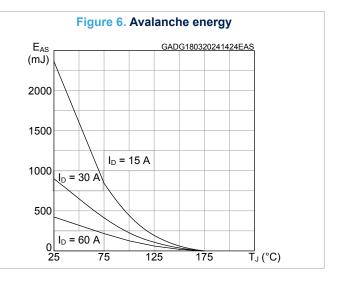












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Figure 7. Normalized on-resistance vs temperature

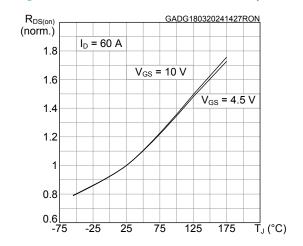


Figure 8. Normalized gate threshold voltage vs temperature

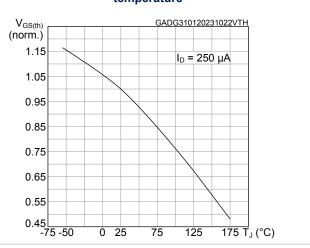


Figure 9. Typical reverse diode forward characteristics

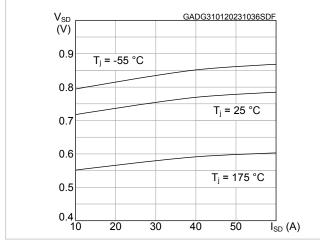


Figure 10. Normalized V_{(BR)DSS} vs temperature

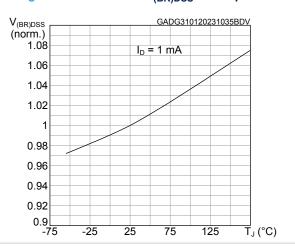


Figure 11. Typical output characteristics

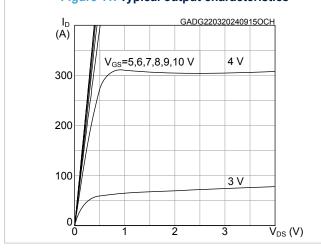
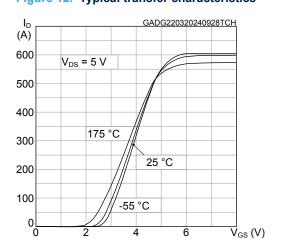


Figure 12. Typical transfer characteristics



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Figure 13. Typical drain-source on-resistance

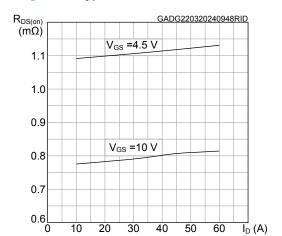


Figure 14. Typical on-resistance vs gate-source voltage

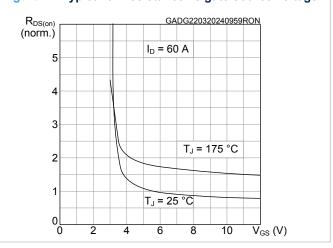


Figure 15. Typical gate charge characteristics

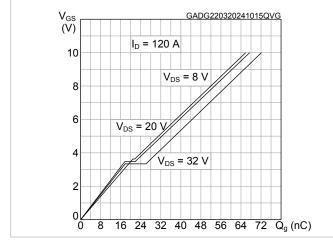
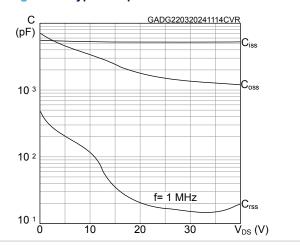


Figure 16. Typical capacitance characteristics



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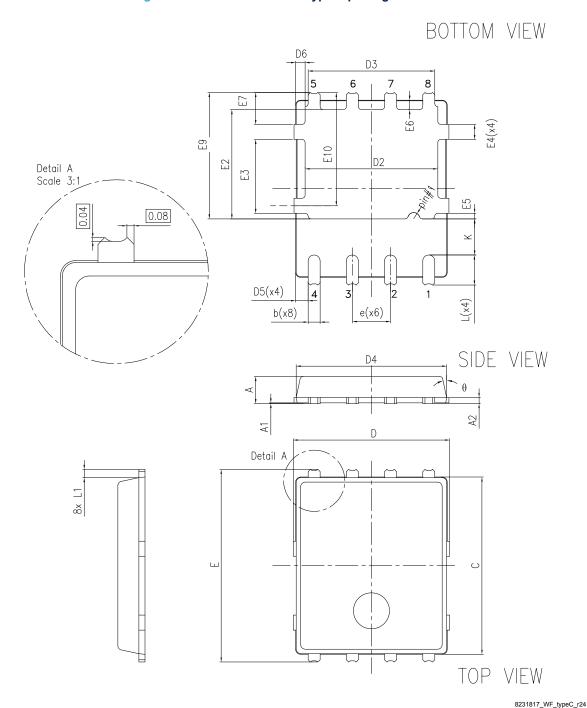


3 Package information

To meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions, and product status are available at: www.st.com. ECOPACK is an ST trademark.

3.1 PowerFLAT 5x6 WF type C package information

Figure 17. PowerFLAT 5x6 WF type C package outline



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Table 7. PowerFLAT 5x6 WF type C mechanical data

Dim.		mm	
Dim.	Min.	Тур.	Max.
Α	0.80		1.00
A1	0.00		0.05
A2	0.20	0.25	0.30
b	0.30		0.50
С	5.80	6.00	6.10
D	5.00	5.20	5.40
D2	4.15		4.45
D3	4.05	4.20	4.35
D4	4.80	5.00	5.10
D5	0.25	0.40	0.55
D6	0.15	0.30	0.45
е		1.27	
E	6.20	6.40	6.60
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
E6	0.20	0.325	0.45
E7	0.85	1.00	1.15
E9	4.00	4.20	4.40
E10	3.55	3.70	3.85
K	1.05		1.35
L	0.90	1.00	1.10
L1	0.175	0.275	0.375
θ	0°		12°

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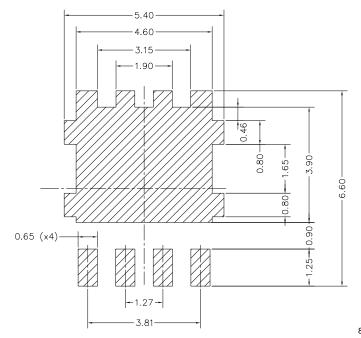
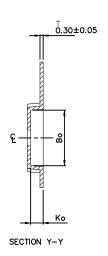


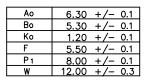
Figure 18. PowerFLAT 5x6 recommended footprint (dimensions are in mm)

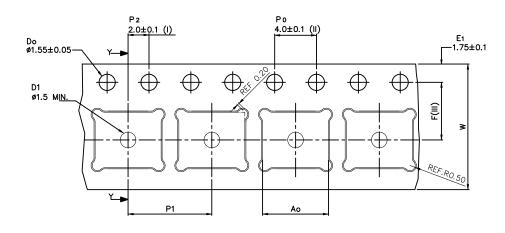
8231817_FOOTPRINT_rev24

3.2 PowerFLAT 5x6 packing information

Figure 19. PowerFLAT 5x6 tape (dimensions are in mm)







- (I) Measured from centreline of sprocket hole to centreline of pocket.
- (II) Cumulative tolerance of 10 sprocket holes is ±0.20.
- (III) Measured from centreline of sprocket hole to centreline of pocket

Base and bulk quantity 3000 pcs All dimensions are in millimeters

8234350_Tape_rev_C

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Figure 20. PowerFLAT 5x6 package orientation in carrier tape

Pin 1 identification

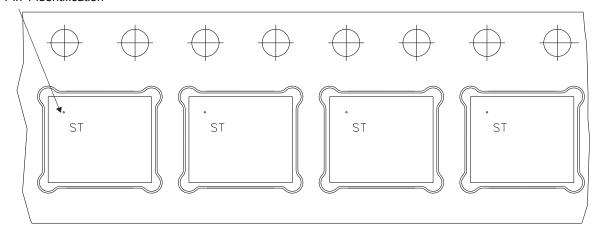
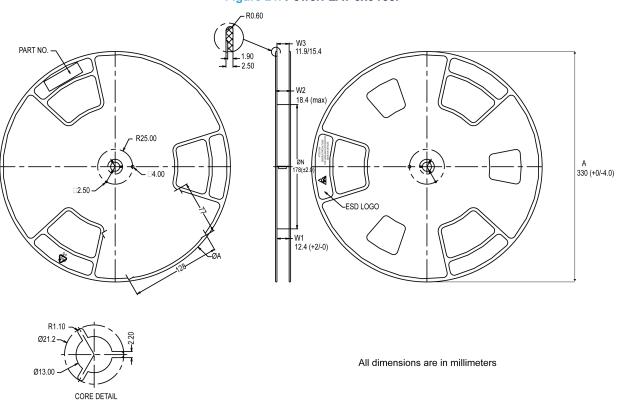


Figure 21. PowerFLAT 5x6 reel



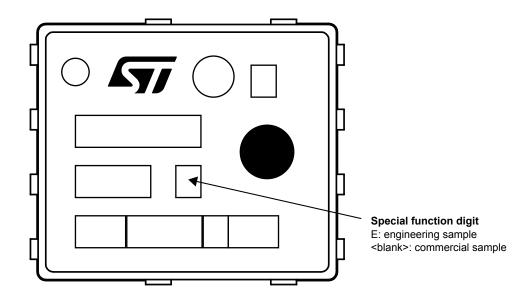
8234350_Reel_rev_C

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3.3 PowerFLAT 5x6 marking information

Figure 22. PowerFLAT 5x6 marking information



Note:

Engineering Samples: these samples can be clearly identified by a dedicated special symbol in the marking of each unit. These samples are intended to be used for electrical compatibility evaluation only; usage for any other purpose may be agreed only upon written authorization by ST. ST is not liable for any customer usage in production and/or in reliability qualification trials.

Commercial Samples: fully qualified parts from ST standard production with no usage restrictions.

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Revision history

Table 8. Document revision history

Date	Revision	Changes
02-Feb-2023	1	Initial release.
26-Apr-2024	2	Updated Features and Applications. Updated Section 1: Electrical ratings and Section 2: Electrical characteristics.
10-Jan-2025	3	Updated Section 3.1: PowerFLAT 5x6 WF type C package information.

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